DECLARATION FOR PATENT APPLICATION

As a below named inventor, I ne								
My residence, post office address	s and citizenship are as stated be	elow next to my name.						
I believe I am the original, first a			al first and joint inventor					
(if plural names are listed below								
invention entitled SUBSTRAT	E FOD THIN FILM MAC		IOD OF					
MANUEL CEUDING THE	CURCERATE :	NETIC HEAD AND MET	HOD OF					
MANUFACTURING THE	SUBSTRATE the specification	on of which is attached hereto u	inless the following box					
is checked:								
was filed on May 13, 2	005 as United States A	nnlication Number or PCT Inte	rnational Application					
was filed on May 13, 2005 as United States Application Number or PCT International Application Number PCT/JP2005/008792 and was amended on (if applicable).								
1 C1/31 2003/000	and was amended	(II appl	icable).					
I hereby state that I have reviewed as amended by any amendment		of the above identified specification	ation, including the claims,					
I acknowledge the duty to disclo	se information which is materia	l to patentability as defined in	37 CFR § 1.56.					
I hereby claim foreign priority b or inventor's certificate, or § 365 than the United States, listed bel certificate, or PCT International claimed.	5(a) of any PCT International ap ow and have also identified belo	oplication which designated at low any foreign application for	east one country other patent or inventor's					
Prior Foreign Application(s)		Priority Date	Priority Claimed					
2004-146493	Japan	17/5/2004	Yes No					
(Number)	Japan (Country) (PCT)	(Day/Month/Year Filed)						
I hereby claim the benefit under	35 U.S.C. § 119(e) of any Unite	ed States provisional applicatio	on(s) listed below.					
(Application Number)		(Filing Date)						
I hereby claim the benefit under International application designs claims of this application is not provided by the first paragraph of patentability as defined in 37 CI national or PCT International file	ating the United States, listed be disclosed in the prior United States of 35 U.S.C. § 112, I acknowled FR § 1.56 which became availab	low and, insofar as the subject ites or PCT International applicates ge the duty to disclose information	matter of each of the cation in the manner ation which is material to					
(Application Number)	(Filing Date)	(Status – patent	(Status – patented, pending, abandoned)					

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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